

RD3R02BBH

Nch 150V 20A Power MOSFET

V _{DSS}	150V
R _{DS(on)} (Max.)	81mΩ
I _D	±20A
P _D	50W

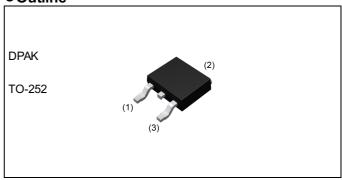
● Features

- 1) Low on resistance
- 2) High Power Package(TO-252)
- 3) Pb-free plating; RoHS compliant
- 4) Halogen Free

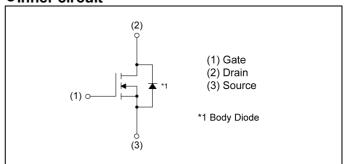
Application

Switching

Outline



●Inner circuit



Packaging specifications

	Packing	Embossed Tape
	Reel size (mm)	330
Туре	Tape width (mm)	16
	Quantity (pcs)	2500
	Taping code	TL1
	Marking	RD3R02BBH

● **Absolute maximum ratings** (T_a = 25°C ,unless otherwise specified)

Parameter	Symbol	Value	Unit	
Drain - Source voltage		V _{DSS}	150	V
Continuous drain current	Continuous drain current V _{GS} = 10V		±20	Α
Pulsed drain current	I _{DP} *2	±80	Α	
Gate - Source voltage	V _{GSS}	±20	V	
Avalanche current, single pulse	I _{AS} *3	13	А	
Avalanche energy, single pulse	E _{AS} *3	6.6	mJ	
Power dissipation	P _D *1	50	W	
Junction temperature	T _j	150	°C	
Operating junction and storage ter	T _{stg}	-55 to +150	°C	

●Thermal resistance

Doromotor	Cymbol	Values			Lloit
Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	R _{thJC} *1	-	1	2.50	°C/W

● Electrical characteristics (T_a = 25°C)

Davamatav	Curahal	Conditions	Values			1.1:4	
Parameter	Parameter Symbol Conditions -		Min.	Тур.	Max.	Unit	
Drain - Source breakdown voltage	V _{(BR)DSS}	$V_{GS} = 0V$, $I_D = 1mA$	150	-	-	V	
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_{j}}$	I _D = 1mA referenced to 25°C	-	98	-	mV/°C	
Zero gate voltage drain current	I _{DSS} V _{DS} = 150V, V _{GS} = 0V		-	-	5	μA	
Gate - Source leakage current	I _{GSS}	I_{GSS} $V_{GS} = \pm 20V, V_{DS} = 0V$		-	±500	nA	
Gate threshold voltage	$V_{GS(th)}$	$V_{GS(th)}$ $V_{DS} = V_{GS}$, $I_D = 1mA$		-	4.0	V	
Gate threshold voltage temperature coefficient	$\frac{\DeltaV_{GS(th)}}{\DeltaT_j}$	I _D = 1mA referenced to 25°C	-	-5.7	-	mV/°C	
Static drain - source	D *4	V _{GS} = 10V, I _D = 10A	-	62	81	O	
on - state resistance	R _{DS(on)} *4	V _{GS} = 6V, I _D = 10A	-	67	100	mΩ	
Gate resistance	R _G -		-	1.5	-	Ω	
Forward Transfer Admittance	Y _{fs} *4	V _{DS} = 5V, I _D = 10A	7.1	-	-	S	

^{*1} T_c=25°C, Limited only by maximum temperature allowed.

^{*2} Pw≤ 10µs , Duty cycle≤ 1%

^{*3} L \simeq 0.1mH, V_{DD} = 75V, R_G = 25 Ω , Starting T_i = 25 $^{\circ}$ C Fig.3-1,3-2

^{*4} Pulsed

● Electrical characteristics (T_a = 25°C)

Daramatar	Symbol .	Conditions		Unit			
Parameter	Parameter Symbol Conditions		Min.	Тур.	Max.	Orill	
Input capacitance	C _{iss}	V _{GS} = 0V	-	730	-		
Output capacitance	C _{oss}	V _{DS} = 75V	-	65	-	pF	
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	12	-		
Turn - on delay time	t _{d(on)} *4	V _{DD} ≈ 75V,V _{GS} = 10V	1	14	1		
Rise time	t _r *4	I _D = 10A	ı	10	1	no	
Turn - off delay time	t _{d(off)} *4	$R_L \simeq 7.5\Omega$	-	28	-	ns	
Fall time	t _f *4	$R_G = 10\Omega$	-	13	-		

● Gate charge characteristics (T_a = 25°C)

Doromotor	Cymahal	Conditions			Values		l loit
Parameter	Symbol			Min.	Тур.	Max.	Unit
Total gate charge	O *4		V _{GS} = 10V	-	12.4	-	
Total gate charge	Q _g *4	V _{DD} ≃ 75V		-	8.1	-	" C
Gate - Source charge	Q _{gs} *4	I _D = 20A	V _{GS} = 6V	-	2.7	-	nC
Gate - Drain charge	Q _{gd} *4			-	3.3	-	

● Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Parameter	Symbol	Conditions		Unit		
	Symbol	TIDOI COINILIOIS		Тур.	Max.	Offic
Continuous forward current	I _S	T _a = 25°C	1	-	20	Α
Pulse forward current	I _{SP} *2	1 _a - 25 C	-	-	80	Α
Forward voltage	V _{SD} *4	$V_{GS} = 0V, I_{S} = 20A$	-	-	1.2	V
Reverse recovery time	t _{rr} *4	I _S = 20A, V _{GS} =0V	-	110	-	ns
Reverse recovery charge	Q _{rr} *4	di/dt = 100A/μs	-	345	-	nC

Fig.1 Power Dissipation Derating Curve

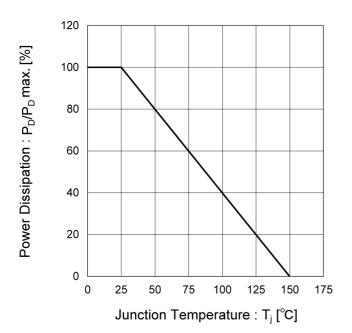


Fig.2 Maximum Safe Operating Area

Operation in this area is limited by $R_{DS}(on)(V_{GS}=10V)$ 10

10

P_W = 100µs

P_W = 10ms

O.01

T_a=25°C
Single Pulse

0.01

1 1 10 100 1000

Drain Current : I_D [A]

Drain - Source Voltage : V_{DS} [V]

Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

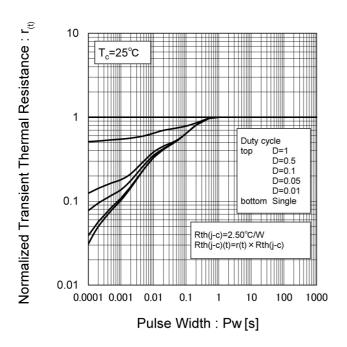


Fig.4 Single Pulse Maximum Power Dissipation

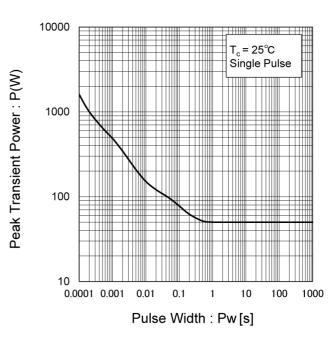
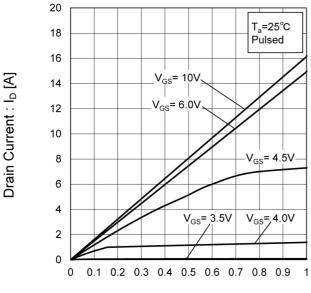
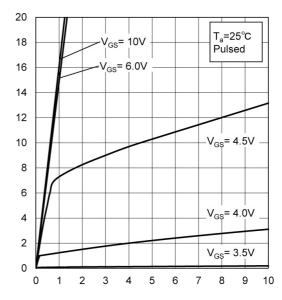


Fig.5 Typical Output Characteristics(I)



Drain - Source Voltage : V_{DS} [V]

Fig.6 Typical Output Characteristics(II)



Drain Current : I_D [A]

Drain - Source Voltage : V_{DS} [V]

Fig.7 Breakdown Voltage vs.
Junction Temperature

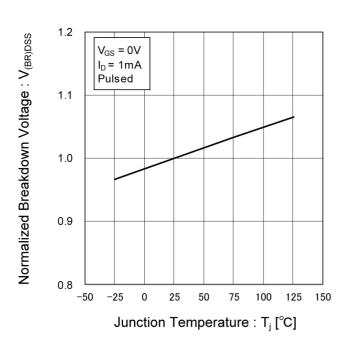
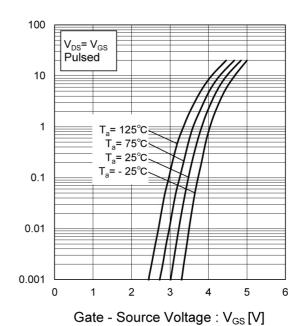


Fig.8 Typical Transfer Characteristics



Drain Current : I_D [A]

Fig.9 Gate Threshold Voltage vs.
Junction Temperature

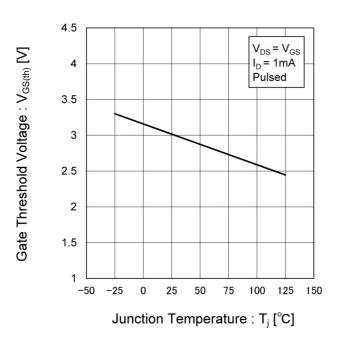


Fig.10 Forward Transfer Admittance vs.
Drain Current

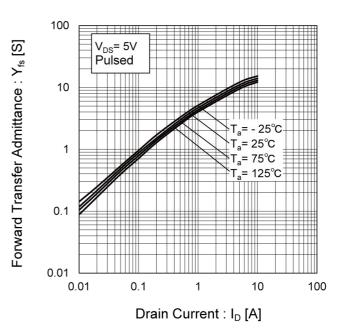


Fig.11 Drain Current Derating Curve

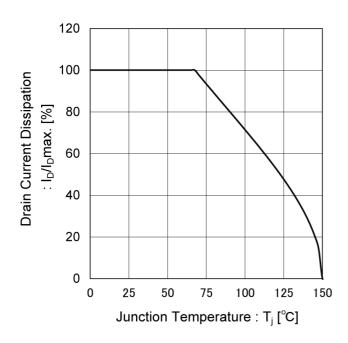


Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage

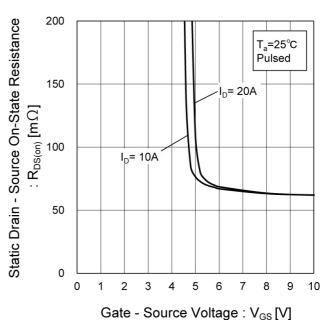


Fig.13 Static Drain - Source On - State
Resistance vs. Junction Temperature

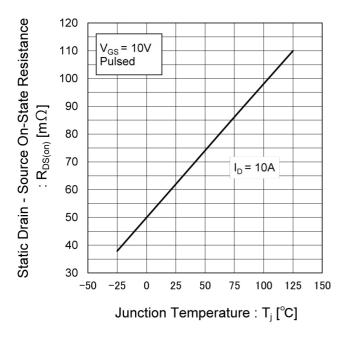


Fig.14 Static Drain - Source On - State
Resistance vs. Drain Current (I)

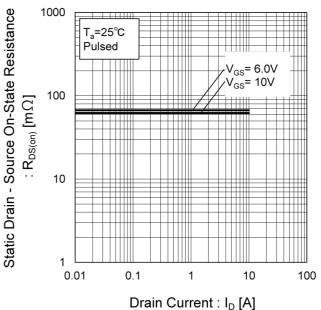


Fig.15 Static Drain - Source On - State Resistance vs. Drain Current (II)

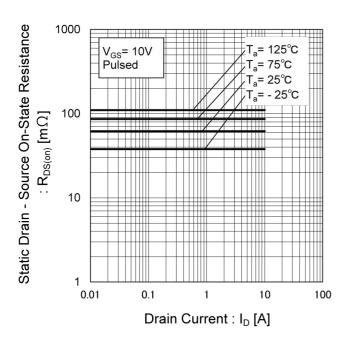


Fig.16 Static Drain - Source On - State Resistance vs. Drain Current (III)

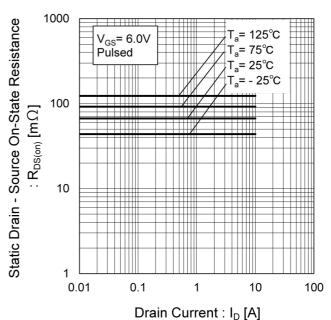


Fig.17 Typical Capacitances vs.

Drain - Source Voltage

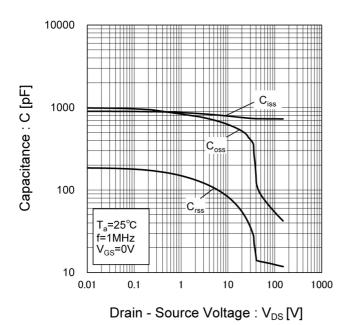


Fig.18 Switching Characteristics

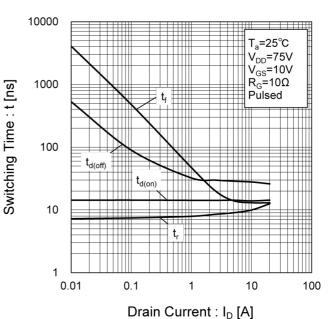


Fig.19 Typical Gate Charge

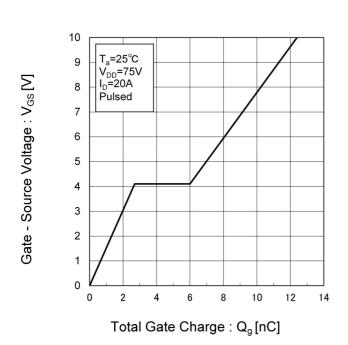
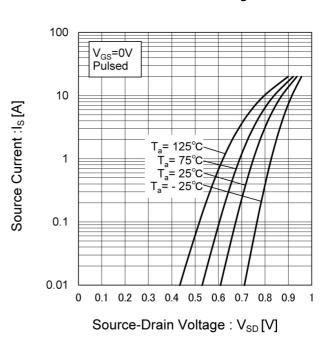


Fig.20 Source Current vs.

Source Drain Voltage



Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

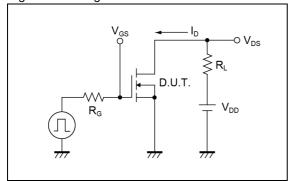


Fig.1-2 Switching Waveforms

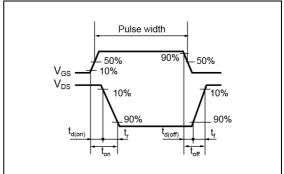


Fig.2-1 Gate Charge Measurement Circuit

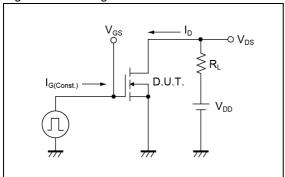


Fig.2-2 Gate Charge Waveform

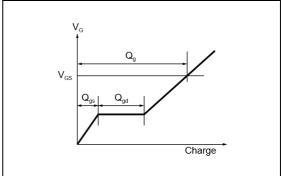


Fig.3-1 Avalanche Measurement Circuit

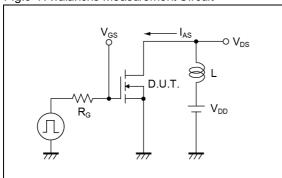
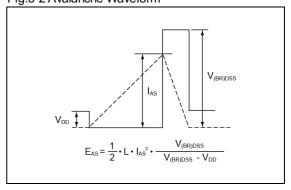
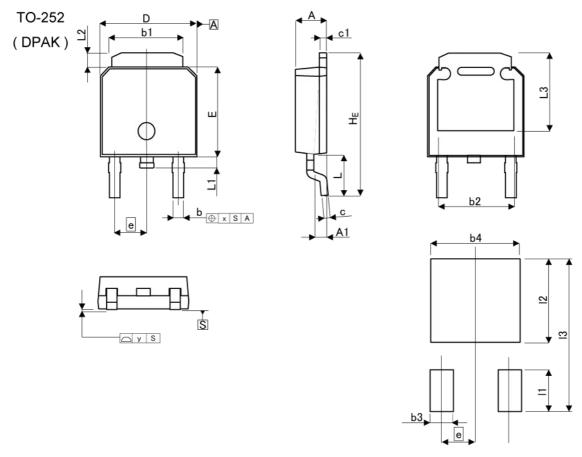


Fig.3-2 Avalanche Waveform



Dimensions



Pattern of terminal position areas [Not a recommended pattern of soldering pads]

DIM	MILIMETERS		INC	HES
DIIVI	MIN	MAX	MIN	MAX
Α	2.20	2.40	0.087	0.094
A1	0.70	1.10	0.028	0.043
b	0.60	0.90	0.024	0.035
b1	5.20	5.50	0.205	0.217
b2	4.	80	0.1	189
С	0.40	0.60	0.016	0.024
c1	0.40	0.60	0.016	0.024
D	6.40	6.80	0.252	0.268
е	2.	30	0.0	91
E	6.00	6.40	0.236	0.252
HE	9.40	10.40	0.370	0.409
L	2.	90	0.1	114
L1	0.60	1.00	0.024	0.039
L2	0.70	1.30	0.028	0.051
L3	5.	30	0.2	209
Х	-	0.25	-	0.010
у	-	0.10	ı - i	0.004
D.11.4	MILIME	MILIMETERS		HES
DIM	MIN	MAX	MIN	MAX
b3	-	1.15	-	0.045
b4	-	5.55	. . .	0.219
I1	-	2.77	(-)	0.109
12	-	5.50	.50	0.217
13	-	10.40	(4)	0.409

Dimension in mm/inches



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CLASSIV	CLASSⅢ	CLASSⅢ	CLASSⅢ

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 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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